

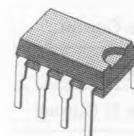
TRISIL
UNIDIRECTIONAL PROGRAMMABLE VOLTAGE AND CURRENT SUPPRESSOR

- HIGH CURRENT CAPABILITY
- PROGRAMMABILITY BOTH IN VOLTAGE AND CURRENT
- AUTOMATIC RECOVERY

DESCRIPTION

The L3100B/B1 is a transient overvoltage suppressor/overcurrent arrester designed to protect sensitive components in electronic telephones and telecommunication equipments against transients caused by lightning, induction from power lines, etc.

The L3100B/B1 characteristic, that is its firing voltage and current, can be easily programmed by means of inexpensive external components ; more over, since this device recovers automatically when the surge current falls below a fixed holding current, it may be used on remotely supplied lines. Finally, if destroyed, it becomes a permanent short circuit.


Minidip
 (Plastic)

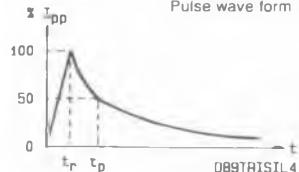
ABSOLUTE RATINGS (limiting values) ($T_j = 25^\circ\text{C}$)

Symbol	Parameter	Value	Unit
I_{pp}	Peak Pulse Current	1 ms expo	A
		8-20 μs expo*	
I_{TSM}	Non Repetitive Surge Peak on-state Current	$t_p = 10 \text{ ms} - \text{Sinus}$	A
dI/dt	Critical Rate of Rise of on-state Current	Non repetitive	$\text{A}/\mu\text{s}$
T_{stg} T_j	Storage and Junction Temperature Range	- 40 to 150 150	$^\circ\text{C}$ $^\circ\text{C}$

THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
$R_{th(j-a)}$	Junction to Ambient	80	$^\circ\text{C}/\text{W}$

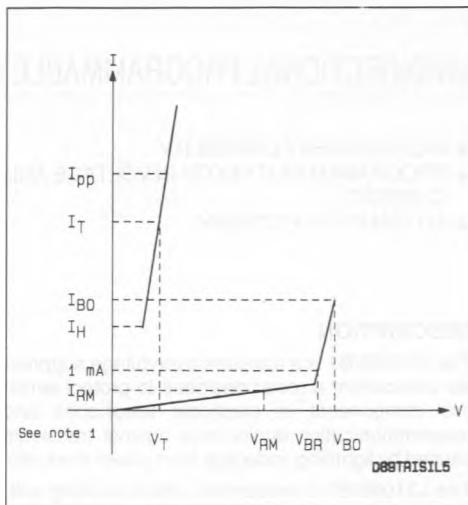
* ANSI STD C62.



ELECTRICAL CHARACTERISTICS

($T_j = 25^\circ\text{C}$)

Symbol	Parameter
V_{RM}	Stand-off Voltage
V_{BR}	Breakdown Voltage
V_{BO}	Clamping Voltage
I_H	Holding Current
V_T	On-state Voltage @ I_T
I_{BO}	Breakover Current
I_{pp}	Peak-pulse Current
V_{GN}	Gate Voltage
I_{GN}	Firing Gate N Current
V_{RGN}	Reverse Gate N Voltage
I_{GP}	Firing Gate P Current



OPERATION WITHOUT GATE

Type	$I_{RM} @ V_{RM}$ max.		V_{BR} min. max. @ I_R		$V_{BO} @ I_{BO}$ max. min. max. See note 2			I_H min.	V_T typ. $I_T = 1 \text{ A}$	C max. $V_R = 5 \text{ V}$ $F = 1 \text{ MHz}$	
	(μA)	(V)	(V)	(V)	(mA)	(V)	(mA)	(mA)			
L3100B/B1	6 40	60 250	255 (3) 265 (4)		1	350	200	500	210 (3) 280 (4)	2	100

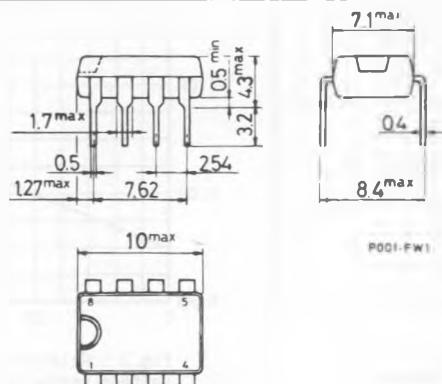
OPERATION WITH GATES

Type	V_{GN} (V) $I_G = 200 \text{ mA}$		I_{GN} (mA) $V_A - C = 100 \text{ V}$		V_{RGN} (V) $I_G = -1 \text{ mA}$		I_{GP} (mA) $V_A - C = 100 \text{ V}$	
	min.	max.	min.	max.	min.	max.	min.	max.
L3100B/B1	0.6	1.8	30	200	0.7			150

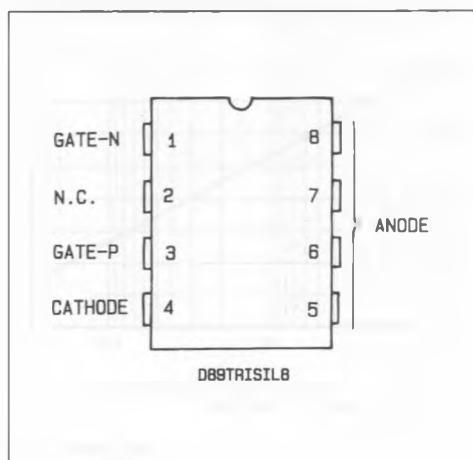
- Notes :
1. Reverse characteristic : $I_R < 1 \text{ mA} @ V_R = 0.7\text{V}$.
 2. These devices are not designed to function as zeners ; continuous operation between 1 mA and I_{BO} will damage them.
 3. L3100B1
 4. L3100B

PACKAGE MECHANICAL DATA

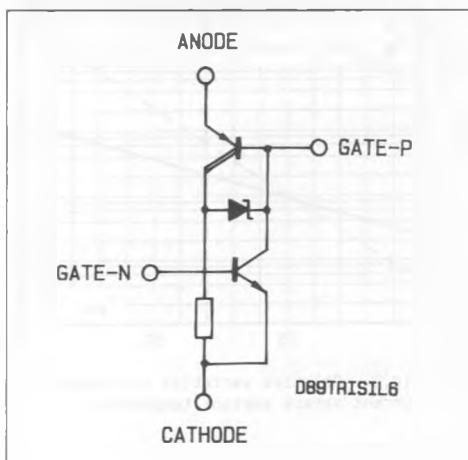
MINIDIP Plastic



CONNECTION DIAGRAM



SCHEMATIC DIAGRAM



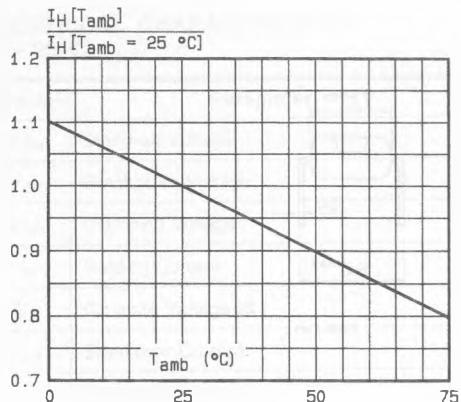


Fig.1 - Relative variation of holding current versus ambient temperature.

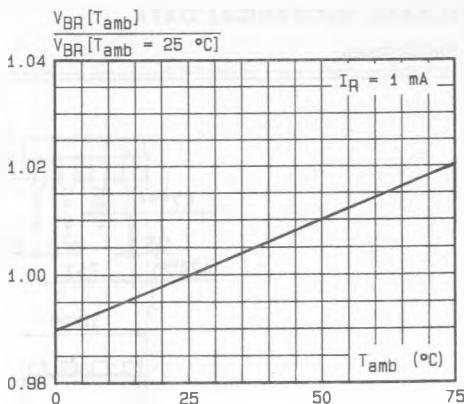


Fig.2 - Relative variation of breakdown voltage versus ambient temperature.

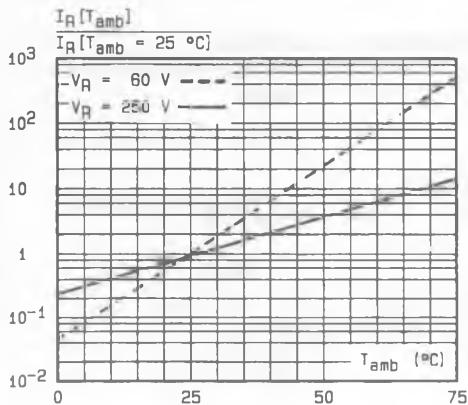


Fig.3 - Relative variation of leakage current versus ambient temperature.

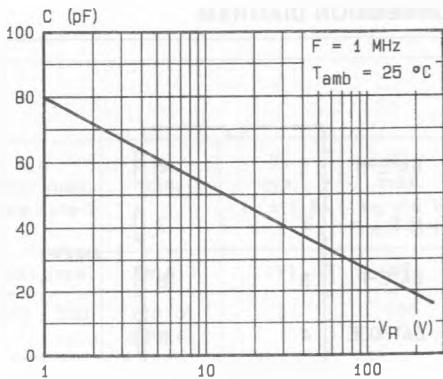


Fig.4 - Junction capacitance versus reverse applied voltage.

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